

SN54ABT16260, SN74ABTH16260 12-BIT TO 24-BIT MULTIPLEXED D-TYPE LATCHES WITH 3-STATE OUTPUTS

SCBS204C – JUNE 1992 – REVISED MAY 1997

- Members of the Texas Instruments *Widebus*™ Family
- State-of-the-Art *EPIC-II B*™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Impedance State During Power Up and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I_{OH} , 64-mA I_{OL})
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Package and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

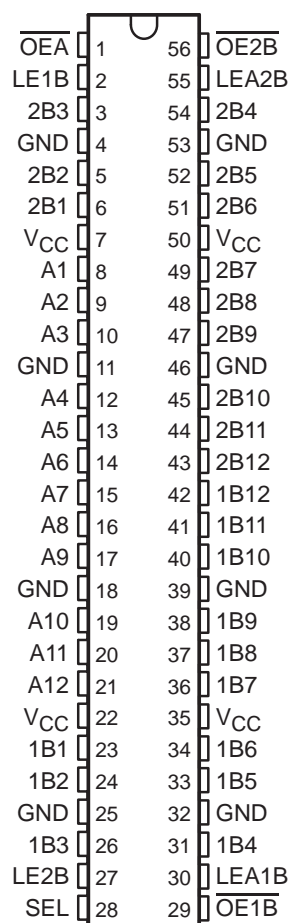
description

The SN54ABT16260 and SN74ABTH16260 are 12-bit to 24-bit multiplexed D-type latches used in applications in which two separate data paths must be multiplexed onto, or demultiplexed from, a single data path. Typical applications include multiplexing and/or demultiplexing of address and data information in microprocessor or bus-interface applications. This device is also useful in memory-interleaving applications.

Three 12-bit I/O ports (A1–A12, 1B1–1B12, and 2B1–2B12) are available for address and/or data transfer. The output-enable ($\overline{OE1B}$, $\overline{OE2B}$, and \overline{OEA}) inputs control the bus-transceiver functions. The $\overline{OE1B}$ and $\overline{OE2B}$ control signals also allow bank control in the A-to-B direction.

Address and/or data information can be stored using the internal storage latches. The latch-enable (LE1B, LE2B, LEA1B, and LEA2B) inputs are used to control data storage. When the latch-enable input is high, the latch is transparent. When the latch-enable input goes low, the data present at the inputs is latched and remains latched until the latch-enable input is returned high.

SN54ABT16260 . . . WD PACKAGE
SN74ABTH16260 . . . DL PACKAGE
(TOP VIEW)



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus and EPIC-II B are trademarks of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1997, Texas Instruments Incorporated

SN54ABT16260, SN74ABTH16260

12-BIT TO 24-BIT MULTIPLEXED D-TYPE LATCHES

WITH 3-STATE OUTPUTS

SCBS204C – JUNE 1992 – REVISED MAY 1997

description (continued)

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN54ABT16260 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABTH16260 is characterized for operation from -40°C to 85°C .

Function Tables

B TO A ($\overline{OEB} = H$)

| INPUTS | | | | | | OUTPUT |
|--------|----|-----|------|------|------------------|--------|
| 1B | 2B | SEL | LE1B | LE2B | \overline{OEA} | A |
| H | X | H | H | X | L | H |
| L | X | H | H | X | L | L |
| X | X | H | L | X | L | A_0 |
| X | H | L | X | H | L | H |
| X | L | L | X | H | L | L |
| X | X | L | X | L | L | A_0 |
| X | X | X | X | X | H | Z |

A TO B ($\overline{OEA} = H$)

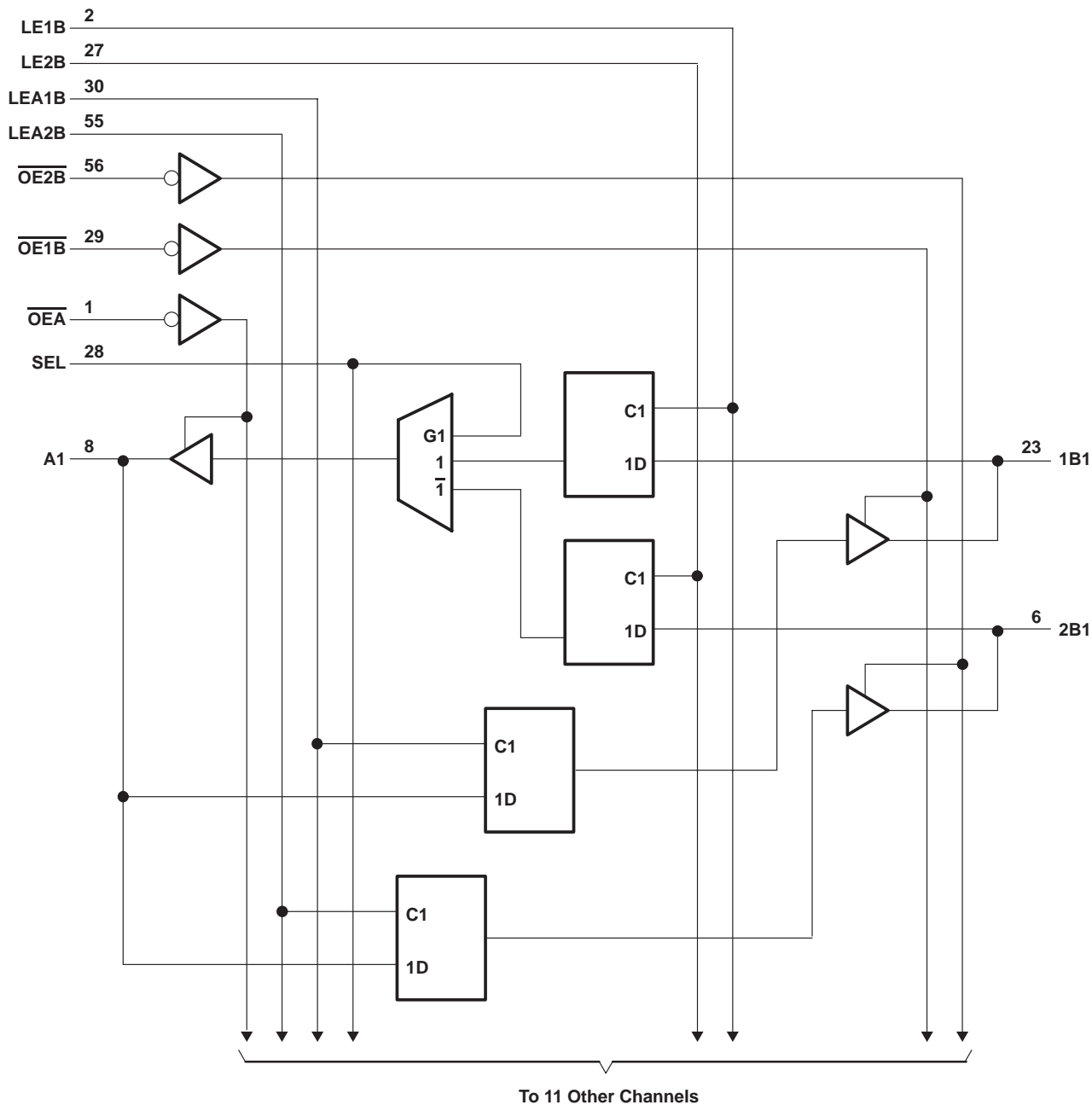
| INPUTS | | | | | OUTPUTS | |
|--------|-------|-------|-------------------|-------------------|---------|--------|
| A | LEA1B | LEA2B | $\overline{OE1B}$ | $\overline{OE2B}$ | 1B | 2B |
| H | H | H | L | L | H | H |
| L | H | H | L | L | L | L |
| H | H | L | L | L | H | $2B_0$ |
| L | H | L | L | L | L | $2B_0$ |
| H | L | H | L | L | $1B_0$ | H |
| L | L | H | L | L | $1B_0$ | L |
| X | L | L | L | L | $1B_0$ | $2B_0$ |
| X | X | X | H | H | Z | Z |
| X | X | X | L | H | Active | Z |
| X | X | X | H | L | Z | Active |
| X | X | X | L | L | Active | Active |



SN54ABT16260, SN74ABTH16260
 12-BIT TO 24-BIT MULTIPLEXED D-TYPE LATCHES
 WITH 3-STATE OUTPUTS

SCBS204C - JUNE 1992 - REVISED MAY 1997

logic diagram (positive logic)



SN54ABT16260, SN74ABTH16260

12-BIT TO 24-BIT MULTIPLEXED D-TYPE LATCHES

WITH 3-STATE OUTPUTS

SCBS204C – JUNE 1992 – REVISED MAY 1997

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|-----------------|
| Supply voltage range, V_{CC} | –0.5 V to 7 V |
| Input voltage range, V_I (see Note 1) | –0.5 V to 7 V |
| Voltage range applied to any output in the high or power-off state, V_O | –0.5 V to 5.5 V |
| Current into any output in the low state, I_O : SN54ABT16260 | 96 mA |
| SN74ABTH16260 | 128 mA |
| Input clamp current, I_{IK} ($V_I < 0$) | –18 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | –50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): DL package | 74°C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

recommended operating conditions (see Note 3)

| | SN54ABT16260 | | SN74ABTH16260 | | UNIT |
|--|-----------------|----------|---------------|----------|------|
| | MIN | MAX | MIN | MAX | |
| V_{CC} Supply voltage | 4.5 | 5.5 | 4.5 | 5.5 | V |
| V_{IH} High-level input voltage | 2 | | 2 | | V |
| V_{IL} Low-level input voltage | | 0.8 | | 0.8 | V |
| V_I Input voltage | 0 | V_{CC} | 0 | V_{CC} | V |
| I_{OH} High-level output current | | –24 | | –32 | mA |
| I_{OL} Low-level output current | | 48 | | 64 | mA |
| $\Delta t/\Delta v$ Input transition rise or fall rate | Outputs enabled | | 10 | 10 | ns/V |
| $\Delta t/\Delta V_{CC}$ Power-up ramp rate | 200 | | 200 | | μs/V |
| T_A Operating free-air temperature | –55 | 125 | –40 | 85 | °C |

NOTE 3: Unused control inputs must be held high or low to prevent them from floating.



SN54ABT16260, SN74ABTH16260 12-BIT TO 24-BIT MULTIPLEXED D-TYPE LATCHES WITH 3-STATE OUTPUTS

SCBS204C – JUNE 1992 – REVISED MAY 1997

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | | T _A = 25°C | | | SN54ABT16260 | | SN74ABTH16260 | | UNIT |
|-----------------------|--|---|-----------------------|------|------|--------------|------|---------------|------|------|
| | | | MIN | TYP† | MAX | MIN | MAX | MIN | MAX | |
| V _{IK} | V _{CC} = 4.5 V, I _I = -18 mA | | -1.2 | | | -1.2 | | -1.2 | | V |
| V _{OH} | V _{CC} = 4.5 V, I _{OH} = -3 mA | | 2.5 | | | 2.5 | | 2.5 | | V |
| | V _{CC} = 5 V, I _{OH} = -3 mA | | 3 | | | 3 | | 3 | | |
| | V _{CC} = 4.5 V | I _{OH} = -24 mA | 2 | | | 2 | | | | |
| | | I _{OH} = -32 mA | 2* | | | | | 2 | | |
| V _{OL} | V _{CC} = 4.5 V | | 0.36 | | | 0.5 | | | | V |
| | | | 0.55* | | | | | 0.55 | | |
| V _{hys} | | | 100 | | | | | | | mV |
| I _I | Control inputs | V _{CC} = 0 to 5.5 V, V _I = V _{CC} or GND | ±1 | | | ±1 | | ±1 | | μA |
| | A or B ports | V _{CC} = 2.1 V to 5.5 V, V _I = V _{CC} or GND | ±20 | | | ±100 | | ±20 | | |
| I _I (hold) | A or B ports | V _{CC} = 4.5 V | 100 | | | 100 | | | | μA |
| | | V _I = 2 V | -100 | | | -100 | | | | |
| I _{OZPU} ‡ | V _{CC} = 0 to 2.1 V, V _O = 0.5 V to 2.7 V, $\overline{OE} = X$ | | ±50 | | | ±50 | | ±50 | | μA |
| I _{OZPD} ‡ | V _{CC} = 2.1 V to 0, V _O = 0.5 V to 2.7 V, $\overline{OE} = X$ | | ±50 | | | ±50 | | ±50 | | μA |
| I _{OZH} § | V _{CC} = 2.1 V to 5.5 V, V _O = 2.7 V, $\overline{OE} \geq 2$ V | | 10 | | | 10 | | 10 | | μA |
| I _{OZL} § | V _{CC} = 2.1 V to 5.5 V, V _O = 0.5 V, $\overline{OE} \geq 2$ V | | -10 | | | -10 | | -10 | | μA |
| I _{off} | V _{CC} = 0, V _I or V _O ≤ 4.5 V | | ±100 | | | | | ±100 | | μA |
| I _{CEX} | V _{CC} = 5.5 V, V _O = 5.5 V | Outputs high | 50 | | | 50 | | 50 | | μA |
| I _O ¶ | V _{CC} = 5.5 V, V _O = 2.5 V | | -50 | -100 | -225 | -50 | -225 | -50 | -225 | mA |
| I _{CC} | V _{CC} = 5.5 V, I _O = 0, V _I = V _{CC} or GND | | 1.5 | | | 1.5 | | 1.5 | | mA |
| | | | 63 | | | 63 | | 63 | | |
| | | | 1 | | | 1 | | 1 | | |
| ΔI _{CC} # | V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND | | 1.5 | | | 1.5 | | 1.5 | | mA |
| C _i | V _I = 2.5 V or 0.5 V | | 3 | | | | | | | pF |
| C _{io} | V _O = 2.5 V or 0.5 V | | 11.5 | | | | | | | pF |

* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V_{CC} = 5 V.

‡ This parameter is characterized, but not production tested.

§ The parameters I_{OZH} and I_{OZL} include the input leakage current.

¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.



SN54ABT16260, SN74ABTH16260

12-BIT TO 24-BIT MULTIPLEXED D-TYPE LATCHES

WITH 3-STATE OUTPUTS

SCBS204C – JUNE 1992 – REVISED MAY 1997

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

| | | $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}^\dagger$ | | SN54ABT16260 | | SN74ABTH16260 | | UNIT |
|----------|--|---|-----|--------------|-----|---------------|-----|------|
| | | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_w | Pulse duration, LE1B, LE2B, LEA1B, or LEA2B high | 3.3 | | 3.3 | | 3.3 | | ns |
| t_{su} | Setup time, data before LE1B, LE2B, LEA1B, or LEA2B↓ | 1.5 | | 2 | | 1.5 | | ns |
| t_h | Hold time, data after LE1B, LE2B, LEA1B, or LEA2B↓ | 1 | | 1.5 | | 1 | | ns |

† These values apply only to the SN74ABTH16260.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | SN54ABT16260 | | | | | UNIT | |
|-----------|-----------------|-------------|---|-----|-----|-----|-----|------|--|
| | | | $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$ | | | MIN | MAX | | |
| | | | MIN | TYP | MAX | | | | |
| t_{PLH} | A or B | B or A | 1 | 3.1 | 5.3 | 1 | 5.9 | ns | |
| t_{PHL} | | | 1 | 3.4 | 5.4 | 1 | 6.3 | | |
| t_{PLH} | LE | A or B | 1.1 | 3.2 | 5.4 | 1.1 | 6.6 | ns | |
| t_{PHL} | | | 1.1 | 3.3 | 5.3 | 1.1 | 5.9 | | |
| t_{PLH} | SEL (B1) | A | 1.3 | 3.2 | 5.1 | 1.3 | 5.4 | ns | |
| | SEL (B2) | | 1.1 | 3.4 | 5.4 | 1.1 | 6.3 | | |
| t_{PHL} | SEL (B1) | | 1.5 | 3.1 | 4.6 | 1.5 | 5 | | |
| | SEL (B2) | | 1.6 | 3.6 | 5.3 | 1.6 | 6.2 | | |
| t_{PZH} | \overline{OE} | A or B | 1 | 3.3 | 5.6 | 1 | 6.4 | ns | |
| t_{PZL} | | | 1.6 | 3.8 | 5.9 | 1.6 | 6.5 | | |
| t_{PHZ} | \overline{OE} | A or B | 2.2 | 4.1 | 5.9 | 2.2 | 7.5 | ns | |
| t_{PLZ} | | | 1.3 | 3.2 | 5 | 1.3 | 5.4 | | |

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figure 1)

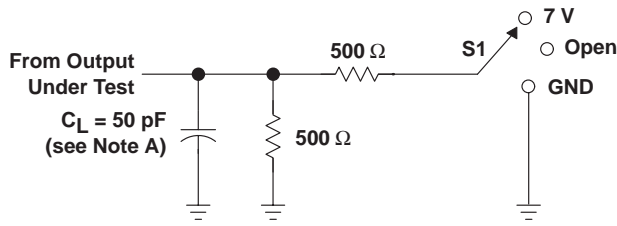
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | SN74ABTH16260 | | | | | UNIT | |
|-----------|-----------------|-------------|---|-----|-----|-----|-----|------|--|
| | | | $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$ | | | MIN | MAX | | |
| | | | MIN | TYP | MAX | | | | |
| t_{PLH} | A or B | B or A | 1 | 3.1 | 4.8 | 1 | 5.6 | ns | |
| t_{PHL} | | | 1 | 3.4 | 5 | 1 | 5.9 | | |
| t_{PLH} | LE | A or B | 1.1 | 3.2 | 4.9 | 1.1 | 5.8 | ns | |
| t_{PHL} | | | 1.1 | 3.3 | 4.9 | 1.1 | 5.3 | | |
| t_{PLH} | SEL (B1) | A | 1.3 | 3.2 | 4.6 | 1.3 | 5.3 | ns | |
| | SEL (B2) | | 1.1 | 3.4 | 4.9 | 1.1 | 6 | | |
| t_{PHL} | SEL (B1) | | 1.5 | 3.1 | 4.4 | 1.5 | 4.4 | | |
| | SEL (B2) | | 1.6 | 3.6 | 5.1 | 1.6 | 5.9 | | |
| t_{PZH} | \overline{OE} | A or B | 1 | 3.3 | 4.7 | 1 | 5.7 | ns | |
| t_{PZL} | | | 1.6 | 3.8 | 5.1 | 1.6 | 5.8 | | |
| t_{PHZ} | \overline{OE} | A or B | 2.2 | 4.1 | 5.4 | 2.2 | 6.4 | ns | |
| t_{PLZ} | | | 1.3 | 3.2 | 4.4 | 1.3 | 4.8 | | |



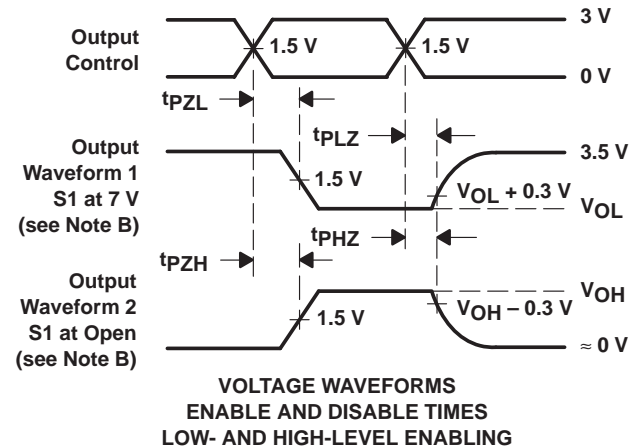
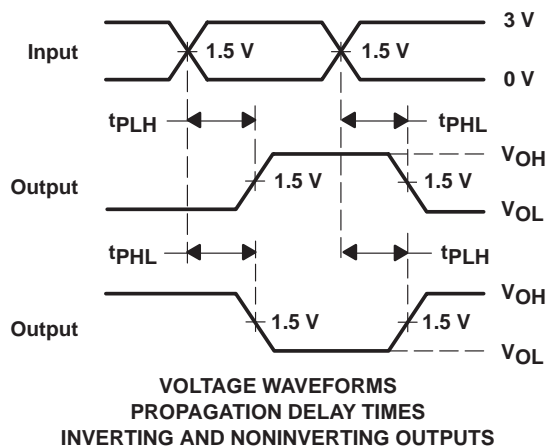
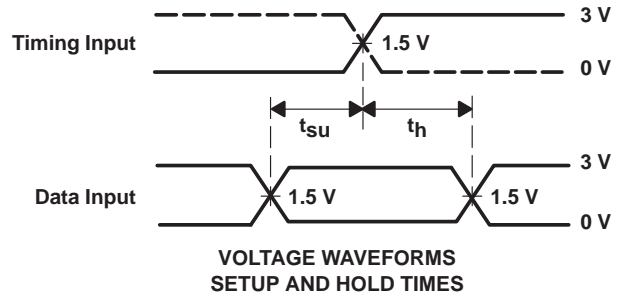
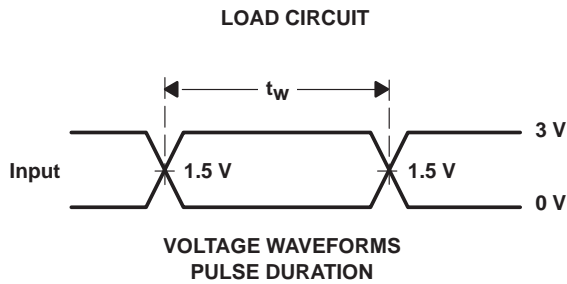
SN54ABT16260, SN74ABTH16260 12-BIT TO 24-BIT MULTIPLEXED D-TYPE LATCHES WITH 3-STATE OUTPUTS

SCBS204C – JUNE 1992 – REVISED MAY 1997

PARAMETER MEASUREMENT INFORMATION



| TEST | S1 |
|-------------------|------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | 7 V |
| t_{PHZ}/t_{PZH} | Open |



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.